19"/2 ® CS1201



High Performance Server

The 3U 19"/2 ® CS1201 is a high-performance server with Intel® Xeon® D processor and removable capability bays for storage, GPU etc.

Small form factor

The MilDef 19"/2 ® (half-rack) form factor is optimized for reduced size, weight, and power (SWaP) to meet industry and military requirements without sacrificing reliability, ruggedness or performance.

Flexible mounting

The 19"/2 ® standard enables flexible mounting options for a wide array of integration scenarios. The unit can be mounted in a standard 19" rack, half rack, or directly on to a surface and in any direction.

Military-relevant rugged design

MilDef products are designed to operate in extreme environmental conditions and challenging electromagnetic operational scenarios. Operationally proven, MilDef products are actively employed in military operations in over 60 countries.

Guaranteed performance

MilDef products are designed for the long lifecycles of military programs and come with a lifetime support program to ensure your equipment maintains peak performance for many missions to come.

We also guarantee the availability of spare parts for an additional 5 years after product end-of-life.

Features

- · Powerful Intel CPU with 20 cores
- Up to 512 GB RAM
- 2x MilDef Capability Bay
- Up to 12x M.2 NVME SSD
- 2x 10G Fiber Ethernet
- Option for NVIDIA Ampere GPU
- iKVM and IPMI support for remote management and monitoring system health



Connector Interfaces	
FAN1-3 (back)	3 connectors which each has:
	• 1x FAN
SERVICE (back)	1x RS232 Service
X1 DC IN (front)	1x Power
	1x Remote
X2 (front)	• 2x 10GBASE-SR
X3 (front)	 1x 1000BASE-T IPMI
X4-X7 (front)	4 connectors which each has:
	• 1x USB3.0
X8 (front)	• 1x DVI-D
X9 (front)	• 1x RS-232

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1x Battery cover (left side)

2x MilDef capability bay, MDB300 Series (front)

1x System button (front)

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Technical Specification	1
Blanking	Enable/disable all externally visible indicators from emitting light via the "blanking command"
Built in test (BIT)	Displayed by status LED
Computer TPM	TPM v2.0 chip
Computer processor	Intel Xeon D-2796TE CPU
IPMI SSIF access	IPMI 2.0
MilDef remote management bus	Enable remote host to perform the following on this device: Power on/off (Gracefully shutdown) Zeroization(if unit supports it) Unit state readback (Unit ready) Blanking
RAM memory	Up to 512 GB ECC RAM
CMOS battery	Replaceable CMOS battery, located behind a cover for easy access
Secure boot	Supported
Zeroization	Zeroization by pressing the system button for 12 sec
Electronics ground to chassis	Isolated
MIL-STD-1275D	5.3.2.2 5.3.2.3 5.3.2.4
Polarity protection	Protected against incorrect polarity connection on the power input within the normal operating

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Power consumption	450 W (with heater)
	350 W (without heater)
Power input	18-36 VDC
Power to chassis	Isolated
Power to electronics ground	Isolated
Chassis material	Aluminum
Coating and color	AE0305-7703520 Axalta (RAL
	7035)
Dimensions width and height	: 220 x 132.3 mm (8.7 x 5.2 in)
g	(WxH)
Earth point	M6 12 mm
	Dealties have
Hot swap	Docking bays
Surface treatment chassis	Chromit-Al
Unit depth	464 mm (18.3 in)
Weight	10.9 kg (24 lbs)
CE	Compliant
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Environmental Specification

Functional shock - Operating	MIL-STD-810H, Method 516.8,
	Procedure I - Functional shock

Table 516.8-IV, Terminal peak sawtooth pulse, Ground materiel 40 g

11 ms

High temperature - Operating MIL-STD-810H, Method 501.7,

Procedure II - Operation

55 °C (131 °F)

High temperature - Storage MIL-STD-810H, Method 501.7,

Procedure I - Storage 71 °C (160 °F)

Humidity MIL-STD-810H, Method 507.6,

Procedure II - Aggravated

95 ± 4% RH Ten 24-hour cycles

IP Class X5

IP Class (Solid Particle IP Class 6X

Protection)

decompression

tection)

IP Class (Water)

Low air pressure - Rapid MIL-STD-810H, Method

500.6, Procedure III - Rapid decompression 2,438 m (8,000 ft)

2,438 m (8,000 ft) 12,192 m (40,000 ft)

Low air pressure - Operating MIL-STD-810H, Method 500.6,

Procedure II - Operation/air

carriage

4,572 m (15,000 ft)

Low temperature - Operating MIL-STD-810H, Method 502.7,

Procedure II - Operation

-40 °C (-40 °F)

Low temperature - Storage MIL-STD-810H, Method 502.7,

Procedure I - Storage

-46 °C (-50.8 °F)



voltage range

Noise level	Maximum noise level of 60 dB SPL A-weighting at 1 m (3.3 ft) distance
Salt fog	MIL-STD-810H, Method 509.7 5 ± 1% (by weight) Two cycles, 24 h wet + 24 h dry / cycle
Temperature shock - Operating	MIL-STD 810H, Method 503.7, Procedure I-C, - Multi-cycle shocks from constant extreme temperature 55 °C (131 °F) -40 °C (-40 °F)
Vibration - Helicopter	MIL-STD-810H, Method 514.8, Procedure I - General vibration, Category 14 - Rotary wing aircraft - helicopter
Vibration - Loose cargo	MIL-STD-810H, Method 514.8, Procedure II - Loose cargo transportation, Category 5 - Truck/trailer - loose cargo
Vibration - Tracked vehicle	MIL-STD-810H, Method 514.8, Procedure I - General vibration, Category 20 - Ground vehicle - ground mobile, Tracked vehicle
Vibration - Wheeled vehicle	MIL-STD-810H, Method 514.8, Procedure I - General vibration, Category 20 - Ground vehicle - ground mobile, Wheeled vehicle
EMC Specification	
EMI conducted CE102	MIL-STD-461F, Method CE102, Conducted emissions, power leads BASIC CURVE 10 kHz - 10 MHz
EMI radiated RE102	MIL-STD-461F, Method RE102, Radiated emissions, electric field Navy Mobile & Army 2 MHz - 18 GHz
EMS conducted CS101	MIL-STD-461F, Method CS101, Conducted susceptibility, power leads CURVE #1 30 Hz - 150 kHz
EMS conducted CS114	MIL-STD-461F, Method CS114, Conducted bulk susceptibility Army, Ground 10 kHz - 200 MHz
EMS conducted CS115	MIL-STD-461F, Method CS115, Conducted susceptibility, bulk
	cable injection, impulse excitation

EMS radiated RS103

MIL-STD-461F, Method RS103, Radiated susceptibility, electric field Army 2 MHz - 1 GHz



cables and power leads 10 kHz - 100 MHz